



3.0A SBR® FULL BRIDGE RECTIFIER

Features

- Dual 30V N-Channel MOSFETs (Q1, Q2) with Dual 3.0A Super Barrier Rectifier Diodes (D1, D2) packaged in a 4.0 x 4.0 x 0.6mm DFN package
- Full-Bridge Rectifier Block
- Super Barrier Rectifiers (D1, D2)
 - Ultra low forward voltage drop
 - Patented Super Barrier Rectifier technology
 - +150°C operating temperature
 - ±8kV ESD protection (HBM, 3B)
 - ±25kV ESD protection (IEC61000-4-2 Level 4, Air Discharge)
- N-Channel MOSFET (Q1, Q2)
 - Low On-Resistance to minimize conduction loss
 - Low Gate Threshold Voltage
 - Low Input Capacitance
 - Fast Switching Speed
 - Low Input/Output Leakage
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)

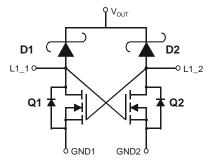
Mechanical Data

- Case: U-DFN4040-8
- Case Material: Molded Plastic, "Green" Molding Compound;
 UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: NiPdAu over Copper Leadframe (Lead-Free Plating);
 Solderable per MIL-STD-202, Method 208
- Terminal Connections: See Diagram
- Weight: 0.031 grams

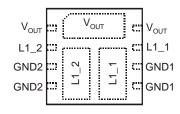
Applications

- Wireless Charging
- AC-DC Rectification
- Optimized for Power Management Applications for Portable Products

U-DFN4040-8



Device Schematic (Dual Channel)



Top View Pin Configuration

Ordering Information (Note 4)

Part Number	Compliance	Case	Packaging
DFBR030U3LP-13	Standard	U-DFN4040-8	4,000/Tape & Reel

Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.
- See http://www.diodes.com/quality/lead_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at http://www.diodes.com/products/packages.html.

Marking Information

FB302 YYWW

U-DFN4040-8

FB302 = Product Type Marking Code YYWW = Date Code Marking YY = Last Digit of Year (ex: 15 for 2015) WW = Week Code (01 to 53)



Maximum Ratings - D1, D2 (@T_A = +25°C, unless otherwise specified.)

Single phase, half wave, 60Hz, resistive or inductive load.

For capacitance load, derate current by 20%

Characteristic	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V _{RRM} V _{RWM} V _{RM}	30	٧
RMS Reverse Voltage	$V_{R(RMS)}$	21	V
Average Rectified Output Current (See Figure 1)	Ιο	3.0	Α
Non-Repetitive Peak Forward Surge Current 8.3ms Single Half Sine-Wave Superimposed on Rated Load	I _{FSM}	20	А

Maximum Ratings – Q1, Q2 (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Units
Input Voltage Between Two MOSFET Drain	V _{LL}	30	V
Drain-Source Voltage	V _{DSS}	30	V
Gate-Source Voltage	V _{GSS}	±20	V
Drain Current (Note 5)	I _D	3.2	Α

Thermal Characteristics

Characteristic	Symbol	Value	Unit
Power Dissipation (Note 5)	P _D	500	mW
Thermal Resistance, Junction to Ambient Air (Note 5)	R _{θJA}	250	°C/W
Power Dissipation (Note 6)	P _D	1000	mW
Thermal Resistance, Junction to Ambient Air (Note 6)	R _{θJA}	125	°C/W
Operating and Storage Temperature Range	T _{J,} T _{STG}	-55 to +150	°C

Electrical Characteristics - D1, D2 (@TA = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
Reverse Breakdown Voltage (Note 7)	$V_{(BR)R}$	30	_	_	V	$I_R = 400\mu A$
		_	0.25	0.278		I _F = 0.1A, T _J = +25°C
		1	0.33	0.37		I _F = 1.0A, T _J = +25°C
Forward Voltage Drop	V	_	0.36	0.42	V	I _F = 2.0A, T _J = +25°C
	VF	l	0.24	0.27		$I_F = 0.1A, T_J = +125$ °C
		l	0.33	0.36		$I_F = 1.0A, T_J = +125$ °C
		l	0.35	0.40		$I_F = 2.0A, T_J = +125$ °C
Leakage Current (Note 7)	I _R	l	50	150	μA	$V_R = 5V, T_J = +25^{\circ}C$
		l	100	400	μA	$V_R = 30V, T_J = +25^{\circ}C$
			6	15	mA	V _R = 5V, T _J = +125°C
		_	10	20	mA	V _R = 30V, T _J = +125°C

Notes: 5. Part mounted on FR-4 board with recommended pad layout, which can be found on our website at http://www.diodes.com.

^{6.} Part mounted on FR-4 board with 1-in sq pad layout, 2oz Cu.

^{7.} Short duration pulse test used to minimize self-heating effect. Pulse width \leq 300 μ s, duty cycle \leq 2%.



Electrical Characteristics - Q1, Q2 (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
DFF CHARACTERISTICS (Note 7)						
Drain-Source Breakdown Voltage	BV _{DSS}	30			V	$V_{GS} = 0V, I_D = 250\mu A$
Zero Gate Voltage Drain Current	I _{DSS}		_	220	μA	$V_{DS} = 30V$, $V_{GS} = 0V$
Gate-Source Leakage	I _{GSS}	_	_	±200	μA	$V_{GS} = \pm 20V, V_{DS} = 0V$
ON CHARACTERISTICS (Note 7)						
Gate Threshold Voltage	V _{GS(th)}	1	_	2.2	V	$V_{DS} = V_{GS}$, $I_D = 250\mu A$
	0		13 17	 26 32	mΩ	$V_{GS} = 10V, I_D = 2.0A$
Static Drain-Source On-Resistance						$V_{GS} = 10V, I_D = 3.2A$
Static Dialii-Source On-Resistance	R _{DS(ON)}	_	22			$V_{GS} = 4.5V, I_D = 2.0A$
			23			$V_{GS} = 4.5V, I_D = 3.2A$
Forward Transconductance	g fs	_	7	_	S	V _{DS} =15V, I _D = 2.0A
Diode Forward Voltage (Note 7)	V _{SD}	0.5		1.2	V	$V_{GS} = 0V, I_S = 2.25A$

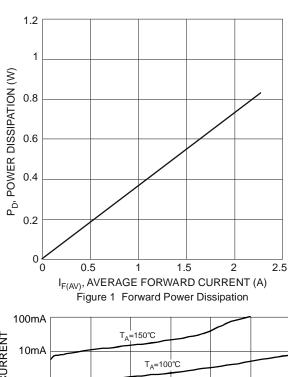
Electrical Characteristics – DFBR030U3LP (@TA = +25°C, unless otherwise specified.)

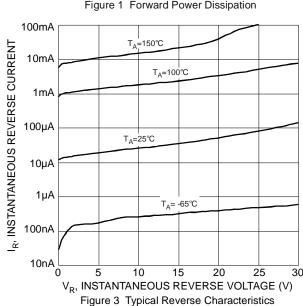
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
Rectifying Forward Voltage (Note 7)	Vfd2		0.45	0.56	V	Input voltage V _{LL} = ±5V; The output current of Rectifier I _{OUT} = 2A
Rectifier leakage current	lleak	_	30	1000		Input voltage V _{LL} = 16V; No Load on the Rectifier output
Rectifier Reverse leakage current	Irleak		20	1000	μΑ	Input voltage $V_{LL} = 0V$; The output voltage of the Rectifier $V_{OUT} = 5V$

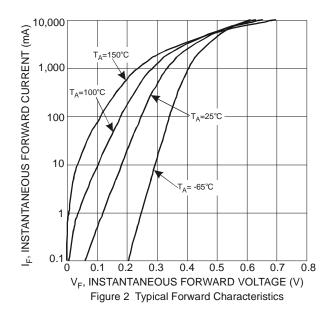
Note: 7. Short duration pulse test used to minimize self-heating effect. Pulse width ≤ 300µs, duty cycle ≤ 2%.

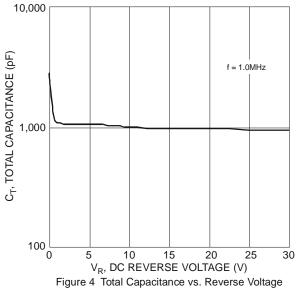


Typical Performance Curves - D1, D2



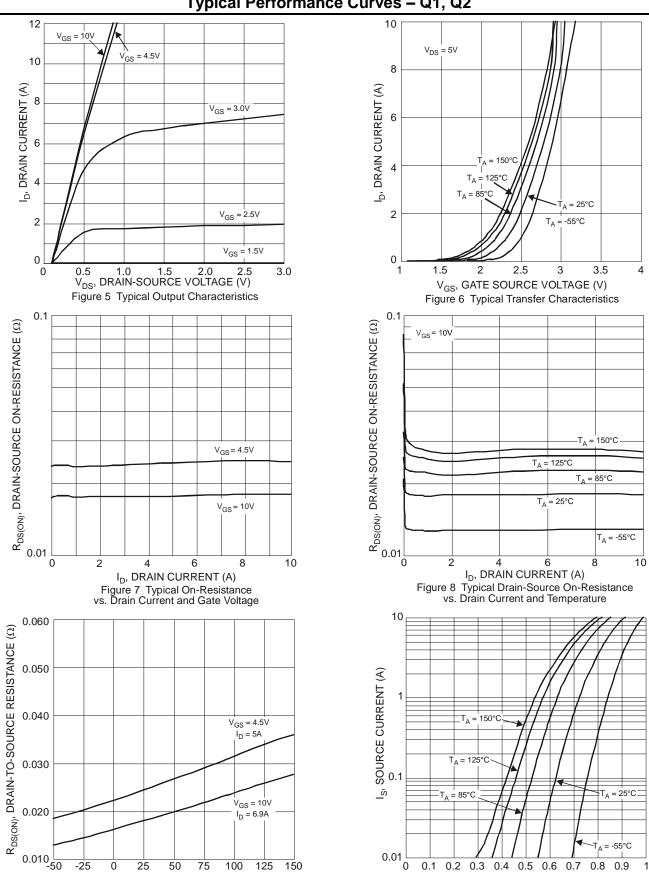








Typical Performance Curves - Q1, Q2



T_J, JUNCTION TEMPERATURE (°C) Figure 9 On-Resistance Variation with Temperature SBR is a registered trademark of Diodes Incorporated.

50

100

125

25

DFBR030U3LP Document number: DS35994 Rev. 8 - 2 0.8 0.9

0.3 0.4 0.5 0.6 0.7

 V_{SD} , SOURCE-DRAIN VOLTAGE (V)

Figure 10 Diode Forward Voltage vs. Current



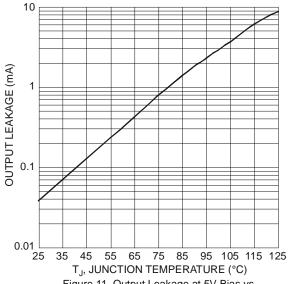


Figure 11 Output Leakage at 5V Bias vs. Junction Temperature

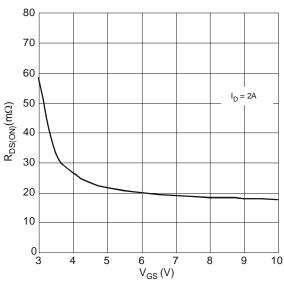


Figure 13 FET Typical On-Resistance vs. Gate-to-Source Voltage (from 3V to 10V)

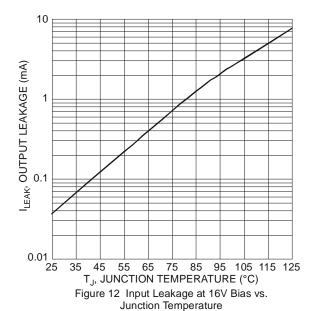
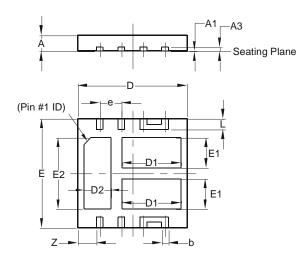


Figure 14 Typical Application Circuit GND1 and GND2 are not internally connected. The user should make the connection in the PCB design.



Package Outline Dimensions

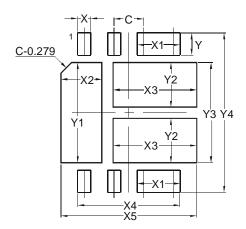
Please see AP02002 at http://www.diodes.com/datasheets/ap02002.pdf for the latest version.



	U-DFN4040-8						
Dim	Min	Max	Тур				
Α	0.57	0.63	0.60				
A1	0	0.05	0.02				
A3	-	-	0.15				
b	0.20	0.30	0.25				
D	3.95	4.05	4.00				
D1	2.05	2.25	2.15				
D2	0.90	1.10	1.00				
Е	3.95	4.05	4.00				
E1	1.00	1.20	1.10				
E2	2.50	2.70	2.60				
е	-	-	0.80				
L	0.35	0.45	0.40				
Z	-	-	0.675				
All C	All Dimensions in mm						

Suggested Pad Layout

Please see AP02001 at http://www.diodes.com/datasheets/ap02001.pdf for the latest version.



Dimensions	Value			
Dilliensions	(in mm)			
С	0.800			
Х	0.350			
X1	1.150			
X2	1.100			
Х3	2.250			
X4	2.750			
X5	3.650			
Υ	0.600			
Y1	2.700			
Y2	1.200			
Y3	2.700			
Y4	4.300			



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